Special Issue

Inventions and Innovation in Smart Sensing Technologies for Agriculture

Message from the Guest Editor

Smart sensing technologies have emerged as powerful tools to enhance productivity, optimize resource utilization, and improve overall agricultural practices. By gathering cutting-edge research and technological advancements in smart sensing technologies, the Special Issue on "Inventions and Innovation of Smart Sensing Technologies in Agriculture" aims to contribute to the advancement of precision agriculture, sustainability, and productivity in the agricultural sector.

Guest Editor

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